Pb Free ROHM Electronic Components RoHS Directive Compliance

Class-AB Speaker Amplifiers

5W+5W Stereo Speaker Amplifiers

BA5406,BA5417

No.11077ECT02

●Description

The BA5406/BA5417 is a dual OTL monolithic power IC with two built-in, high output speaker amplifier circuits. High output of 5W×2 can be produced when V_{CC}=12 V and R_L=3Ω, and 2.8 W×2 when V_{CC}=9V and R_L=3Ω. The BA5406, which uses a high allowable power dissipation package, has a simple heatsink design. The BA5417 not only exceeds basic characteristics, but also has a built-in soft clip circuit, thermal shutdown and standby circuits.

●Features

BA5406
1) Good low voltage characteristics (Operation from Vcc=5 V)
2) Ripple filter (6pin) also can be used as muting pin (Make 6pin GND potential)
3) Small thermal resistance package and simple heatsink design

BA5417
1) Small pop noise when standby switches ON/OFF
2) Built-in circuit to prevent ripple addition when motor starts
3) Built-in thermal shutdown circuit
4) Built-in standby switch circuit
5) Built-in soft clip circuit

●Applications

Stereo radio cassette players, mini-audio systems, LCD TVs, etc.

●Line up matrix

Part No.	BA5406	BA5417	Units
Supply voltage	5 ~ 15	6 ~ 15	V
Power dissipation	20	15	W
Quiescent current	40	22	mA
Standby current	—	0	μA
Closed loop voltage gain	46	45	dB
Output noise voltage	0.6	0.3	mVrms
Total harmonic distortion	0.3	0.1	%
Ripple rejection	—	55	dB
Package	SIP-M12	HSIP15	—

●Absolute maximum ratings (Ta=25℃)

Parameter	Symbol	Ratings		Unit
		BA5406	BA5417	
Supply voltage	Vcc	18 *1	20 *1	V
Power dissipation	Pd	20 *2	15 *3	W
Operating temperature	Topr	-20 ~ +75	-20 ~ +75	℃
Storage temperature	Tstg	-30 ~ +125	-55 ~ +150	℃

*1 When no signal
*2 Back metal temperature 75℃
*3 Ta=75°C (Using infinite heatsink)

●Operating range (Ta=25℃)

Parameter	Symbol	Ratings		Unit
		BA5406	BA5417	
Supply voltage	V_{CC}	5.0 ~ 15.0	6.0 ~ 15.0	V

●Electrical characteristics (BA5406 : Unless otherwise noted, Ta=25℃, Vcc=12V)
(BA5417 : Unless otherwise noted, Ta=25℃, Vcc=9V)

Parameter		Symbol	Limits		Unit.	Conditions
			BA5406	BA5417		
Quiescent current		I_O	40	22	mA	V_{IN}=0Vms
Rated output power		P_{OUT}	5.0	5.0	W	THD=10%,Vcc=12V, RL=3Ω
Closed loop voltage gain		G_{VC}	46	45	dB	—
Output noise voltage		V_{NO}	0.6	0.3	mVrms	Rg=10kΩ, DIN-Audio
Total harmonic distortion		THD	0.3	0.1	%	P_{OUT}=0.5W, f=1kHz
Ripple rejection		RR	—	55	dB	f_{RR}=100Hz,V_{RR}=-10dBm
Crosstalk		CT	—	65	dB	V_O=0dBm
Standby current		I_{OFF}	—	0	μA	—
Standby pin input current		I_{SIN}	—	0.15	mA	V_{STBY}=V_{CC}
Standby pin control voltage	Activated	V_{STH}	—	3.5 ~ Vcc	V	—
	Not Activated	V_{STL}	—	0 ~ 1.2	V	—

* Note: This IC is not designed to be radiation-resistant.

●Block diagram

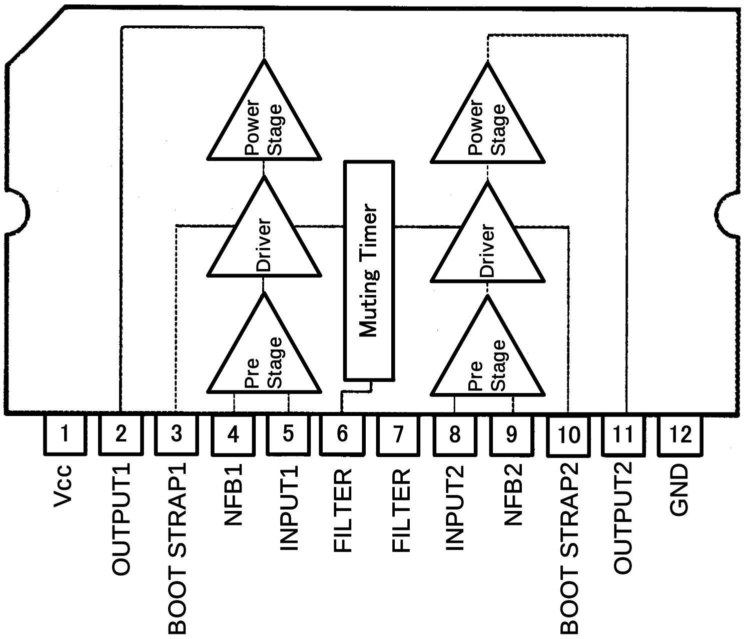


Fig.1 BA5406

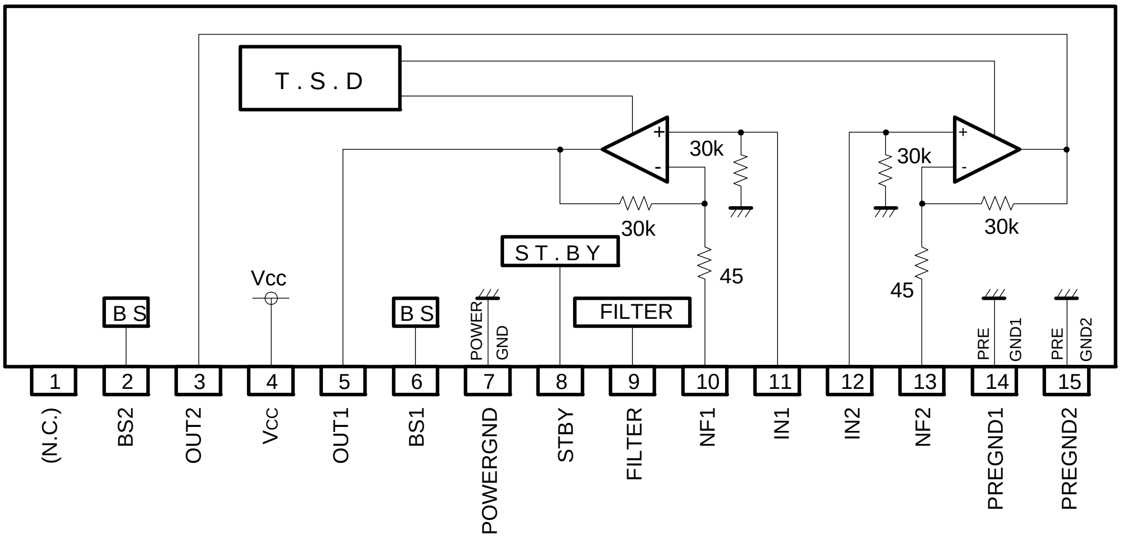


Fig.2 BA5417

●Measurement circuit

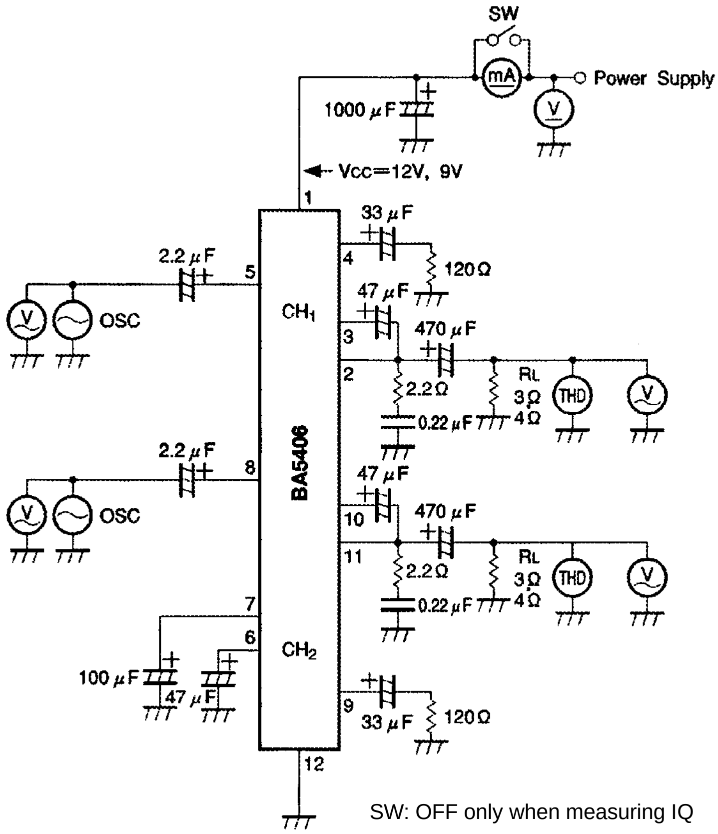


Fig.3 BA5406

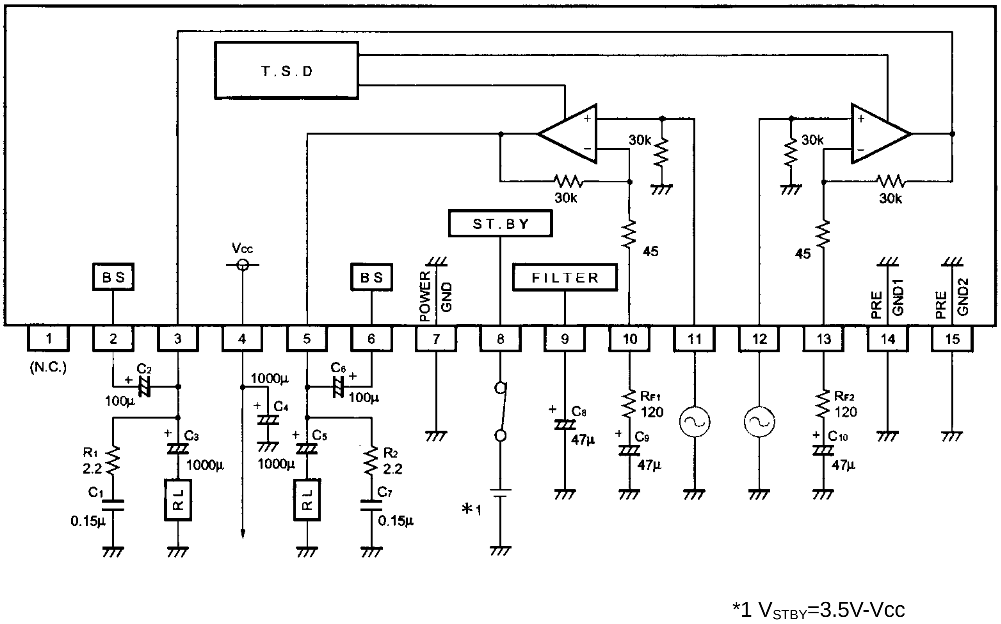


Fig.4 BA5417

●Application circuit

BA5406

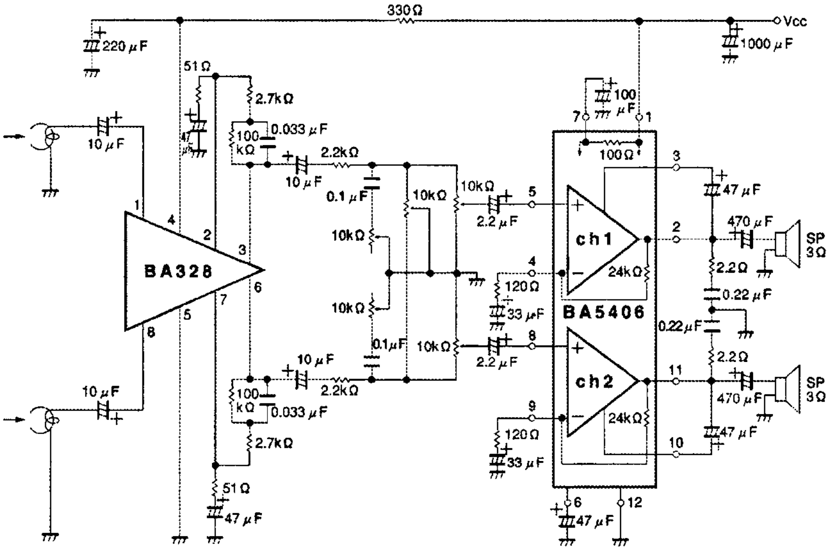


Fig.5

BA5417

OTL mode circuit

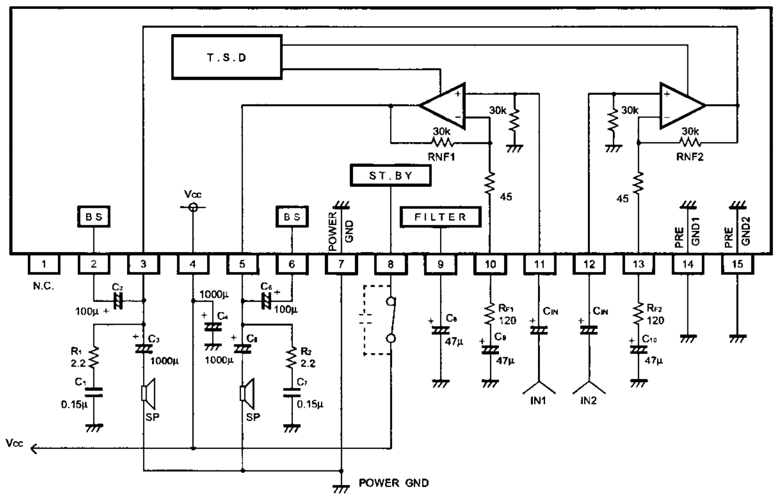


Fig.6

BTL mode circuit

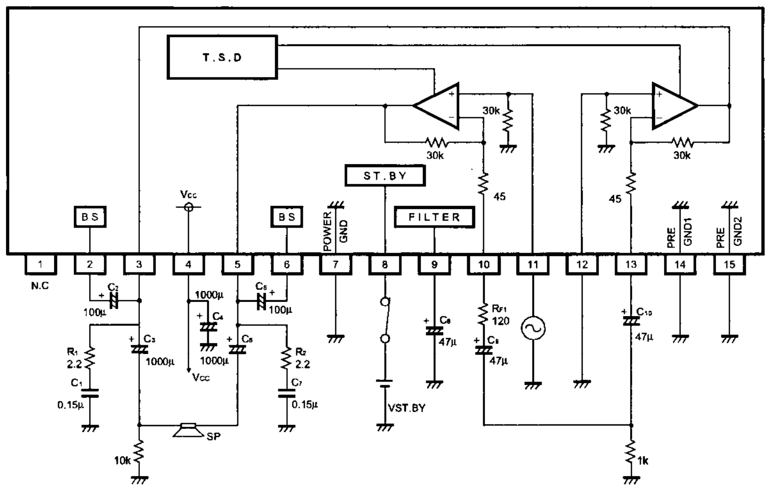


Fig.7

●Reference data

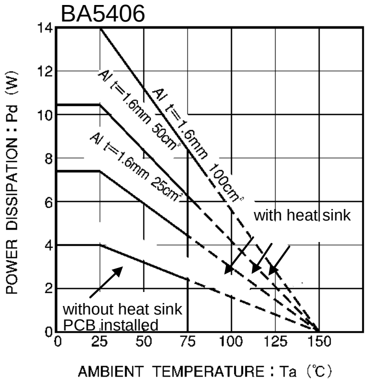


Fig.8 Thermal derating curve

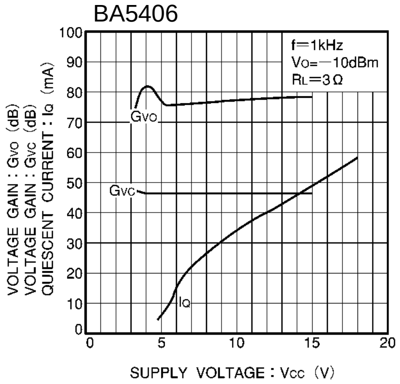


Fig.9 Quiescent current and voltage gain vs Supply voltage

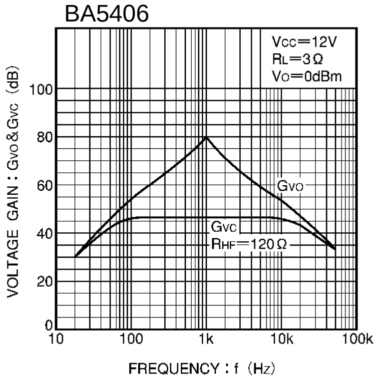


Fig.10 Voltage gain vs frequency

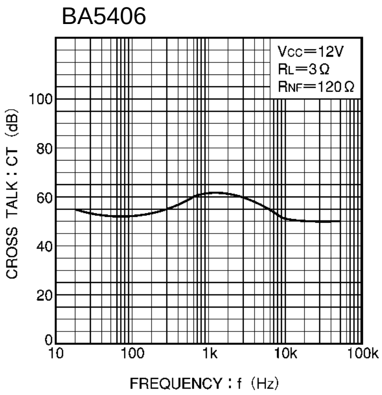


Fig.11Crosstalk vs frequency

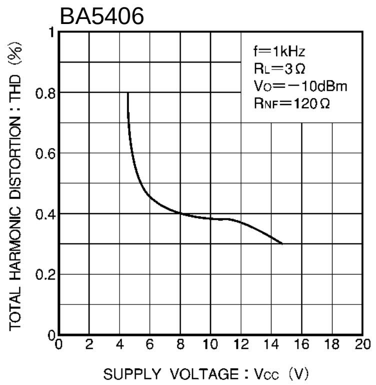


Fig.12 Distortion vs power supply voltage

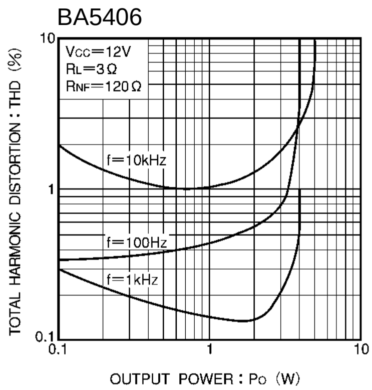


Fig.13 Distortion vs Output power

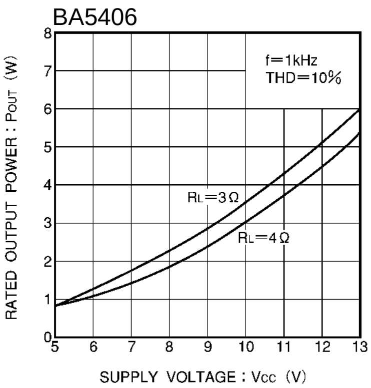


Fig.14 Output power
vs power supply voltage

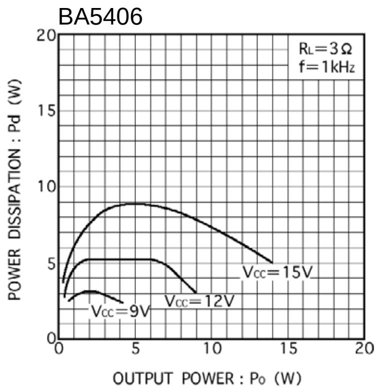


Fig.15 Power dissipation
vs Output power(1)

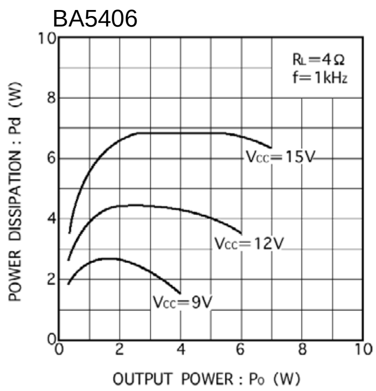


Fig.16 Power dissipation
vs Output power(2)

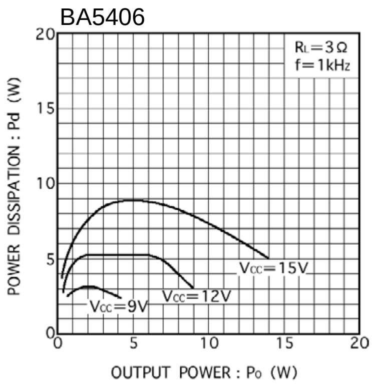


Fig. 17 Power dissipation
vs Output power(3)

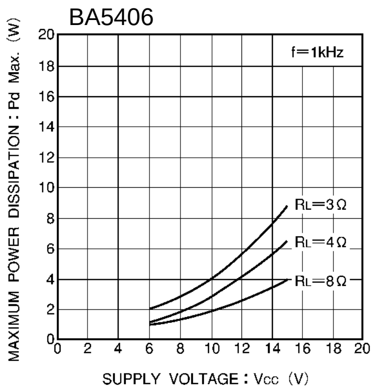


Fig.18 Muximum power dissipation
vs Supply voltage

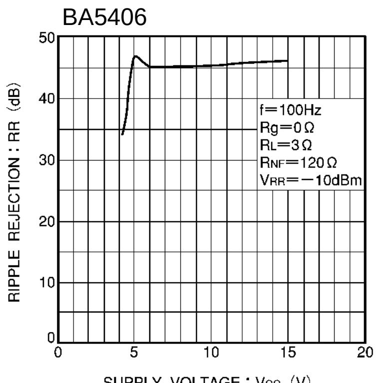


Fig.19 Ripple rejection ratio
vs Supply voltage

BA5417 OTL mode

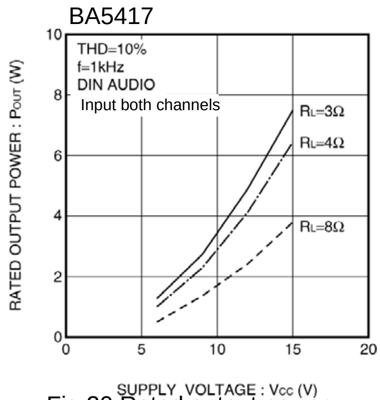


Fig.20 Rated output power vs Supply voltage

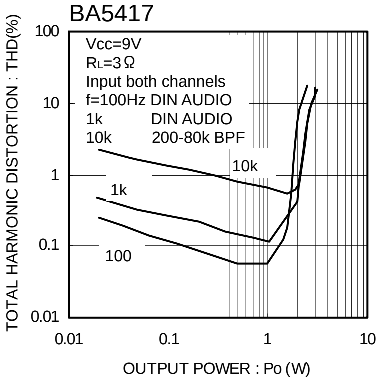


Fig.21 Total harmonic distortion vs Output power

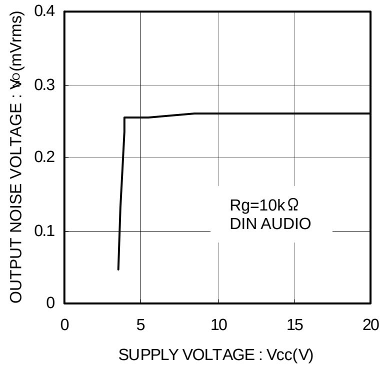


Fig.22 Output noise voltage vs Supply voltage

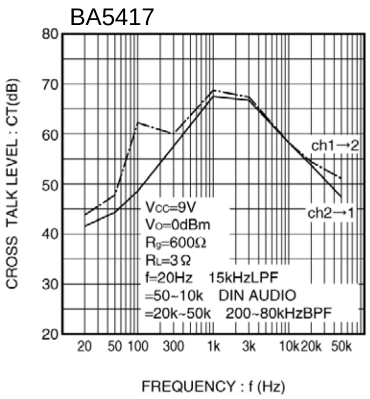


Fig.23 Crosstalk vs. Frequency

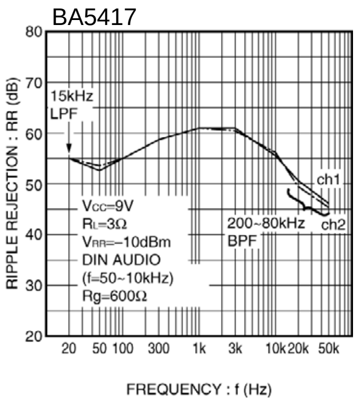


Fig.24 Ripple rejection vs. Frequency

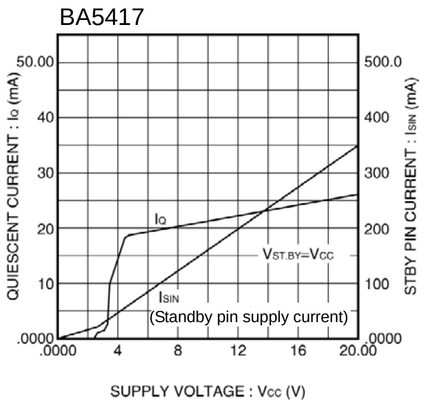


Fig.25 Quiescent, standby pin input current vs. Supply voltage

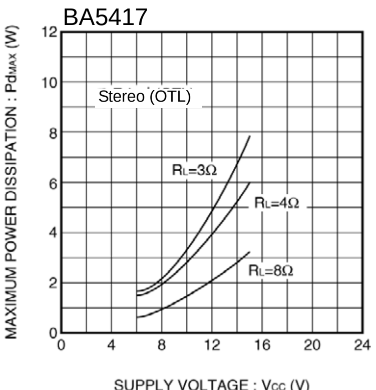


Fig.26 Maximum power dissipation vs. Supply voltage

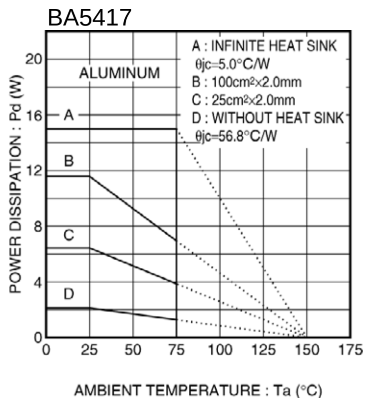


Fig.27 Thermal derating curve

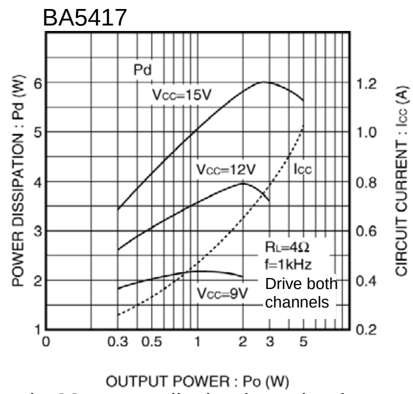


Fig.28 Power dissipation, circuit current vs. Supply Voltage(RL=4Ω)

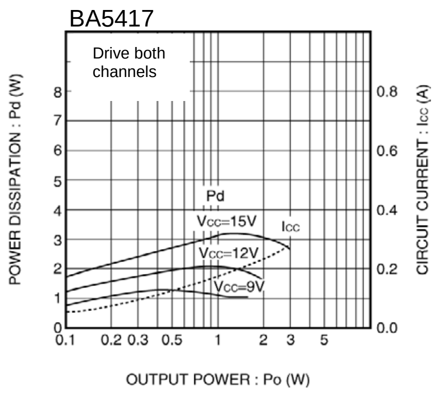


Fig.29 Power dissipation, circuit current vs. Supply Voltage（RL=8Ω）

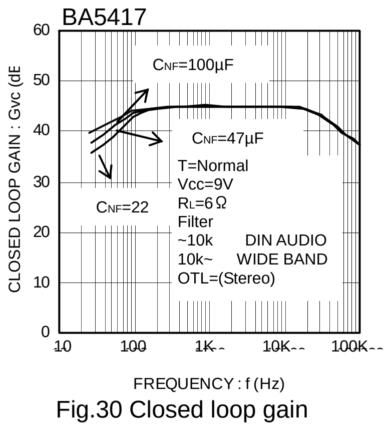


Fig.30 Closed loop gain vs. Frequency

BA5417 BTL mode

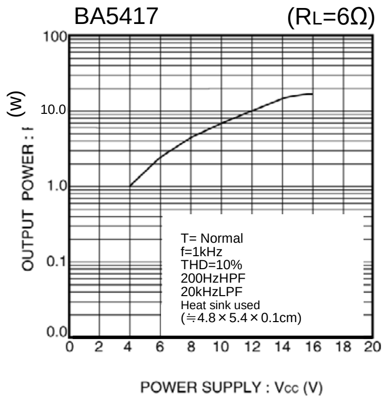


Fig.31 Rated output power vs. Supply Voltage

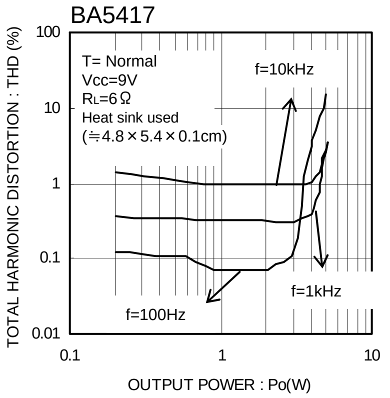


Fig.32 Total harmonic distortion vs. Output power

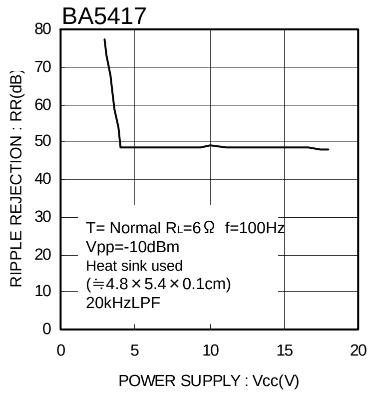


Fig.33 Ripple rejection ratio vs. Supply Voltage

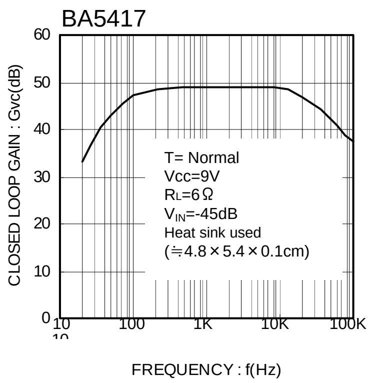


Fig.34 Close loop gain vs. Frequency

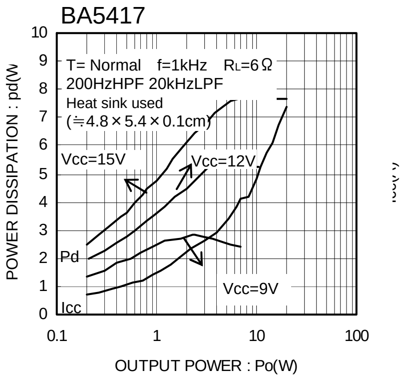


Fig.35 Power dissipation, Supply current vs. Frequency

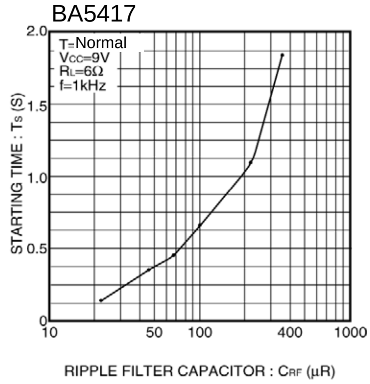


Fig.36 Starting time vs. Ripple filter capacitor

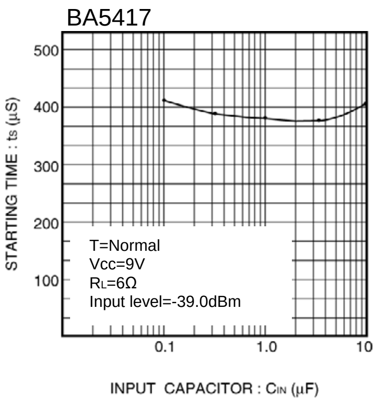


Fig.37 Starting time vs. Input coupling capacitor

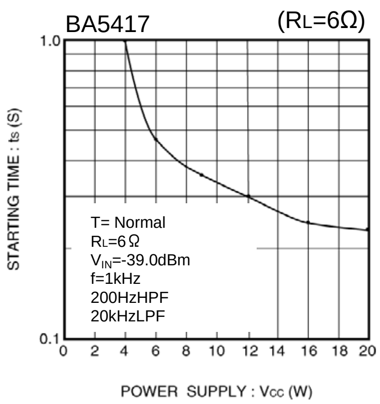


Fig.38 Starting time vs. Supply Voltage

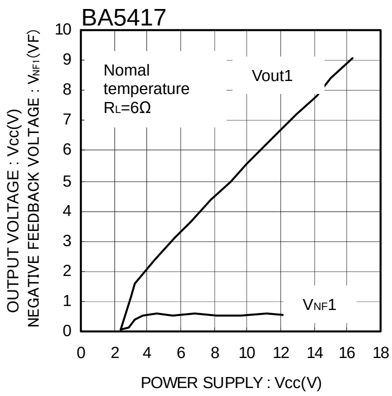


Fig.39 Output voltage, Negative feed back voltage vs. Supply Voltage

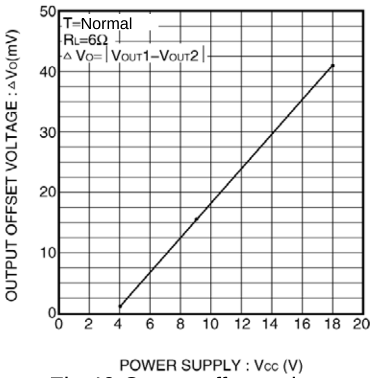


Fig.40 Output offset voltage vs. Supply Voltage

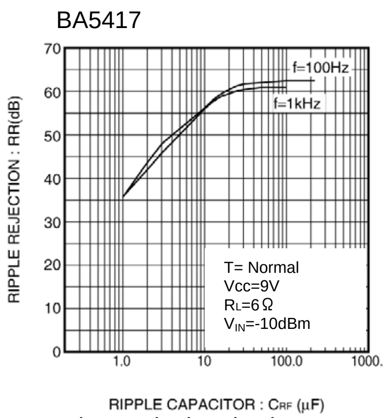


Fig.41 Ripple rejection vs. Ripple filter capacitor

●Notes for use

1) Numbers and data in entries are representative design values and are not guaranteed values of the items.

2) Although ROHM is confident that the example application circuit reflects the best possible recommendations, be sure to verify circuit characteristics for your particular application. Modification of constants for other externally connected circuits may cause variations in both static and transient characteristics for external components as well as this Rohm IC. Allow for sufficient margins when determining circuit constants.

3) Absolute maximum ratings
Use of the IC in excess of absolute maximum ratings, such as the applied voltage or operating temperature range (Topr), may result in IC damage. Assumptions should not be made regarding the state of the IC (short mode or open mode) when such damage is suffered. A physical safety measure, such as a fuse, should be implemented when using the IC at times where the absolute maximum ratings may be exceeded.

4) GND potential
Ensure a minimum GND pin potential in all operating conditions. Make sure that no pins are at a voltage below the GND at any time, regardless of whether it is a transient signal or not.

5) Thermal design
Perform thermal design, in which there are adequate margins, by taking into account the permissible dissipation (Pd) in actual states of use.

6) Short circuit between terminals and erroneous mounting
Pay attention to the assembly direction of the ICs. Wrong mounting direction or shorts between terminals, GND, or other components on the circuits, can damage the IC.

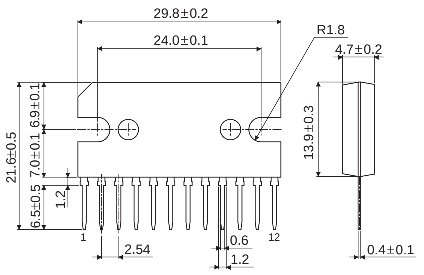
7) Operation in strong electromagnetic field
Using the ICs in a strong electromagnetic field can cause operation malfunction.

●Ordering part number

B	A		5	4	0	6				-		

- Part No.
- Part No.: 5406, 5417
- Package: None: SIP-M12, HSIP15
- Packaging and forming specification: None: Tube

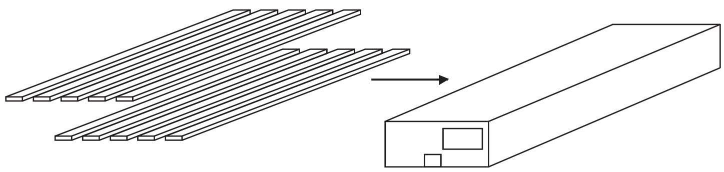
SIP-M12



(Unit : mm)

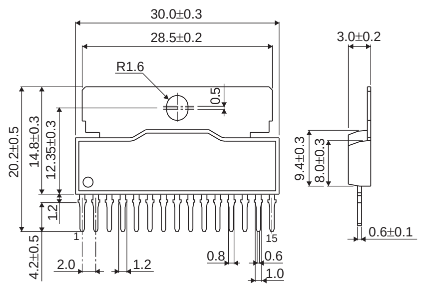
<Tape and Reel information>

Container	Tube
Quantity	300pcs
Direction of feed	Direction of products is fixed in a container tube



＊Order quantity needs to be multiple of the minimum quantity.

HSIP15



(Unit : mm)

<Tape and Reel information>

Container	Tube
Quantity	300pcs
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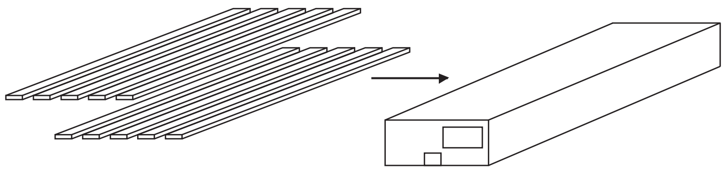

＊Order quantity needs to be multiple of the minimum quantity.

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